

0.8A, 200V - 1000V Surface Mount Rectifier

FEATURES

- · Glass passivated junction chip
- Ideal for automated placement
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

MECHANICAL DATA

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 16mg (approximately)

KEY PARAMETERS					
PARAMETER VALUE UNIT					
I _{F(AV)}	0.8	Α			
V_{RRM}	200 - 1000	V			
I _{FSM}	20	Α			
T _{J MAX}	150 °C				
Package	SOD-123W				
Configuration	Single die				





SOD-123W

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	SDLW	SGLW	SJLW	SKLW	SMLW	UNIT
Marking code on the device		DLW	GLW	JLW	KLW	MLW	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current	I _{F(AV)}			0.8			Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	20		А			
Junction temperature	T_J	-55 to +150		°C			
Storage temperature	T _{STG}	-55 to +150		°C			





THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	30	°C/W			
Junction-to-ambient thermal resistance per diode	R _{OJA}	84	°C/W			
Junction-to-case thermal resistance per diode	R _{eJC}	31	°C/W			

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
	$I_F = 0.4A, T_J = 25^{\circ}C$	V _F	0.89	0.98	V	
Forward voltage per diode (1)	$I_F = 0.8A, T_J = 25^{\circ}C$		0.94	1.10	V	
	$I_F = 0.4A, T_J = 125$ °C		0.77	0.93	V	
	$I_F = 0.8A, T_J = 125^{\circ}C$		0.84	1.01	V	
Deverse surrent @ reted V per diede (2)	T _J = 25°C	,	-	1	μA	
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 125°C	l _R	-	150	μA	
Junction capacitance	1 MHz, V _R =4.0V	CJ	7	-	pF	

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION						
PART NO.	PART NO. SUFFIX(*)	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING	
SxLW		RV	G	SOD-123W	3,000 / 7" Reel	
(Note 1,2)	Н	RQ		SOD-123W	10,000 / 13" Reel	

Notes:

- 1. "x" defines voltage from 200V (SDLW) to 1000V (SMLW)
- 2. Whole series with green compound (halogen-free)
- *: Optional available

EXAMPLE P/N						
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
SMLWHRVG	SMLW	Н	RV	G	AEC-Q101 qualified Green compound	

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CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

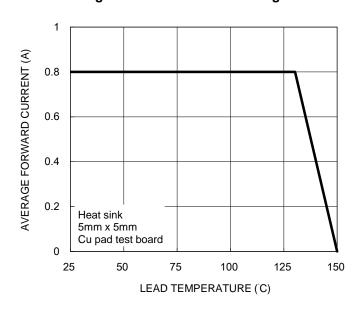


Fig.2 Typical Junction Capacitance

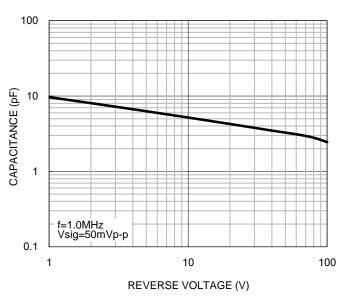


Fig.3 Typical Reverse Characteristics

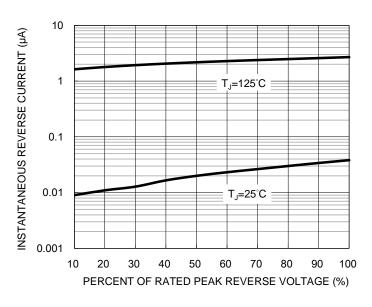
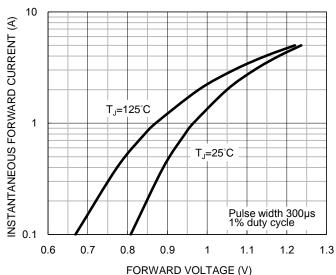


Fig.4 Typical Forward Characteristics

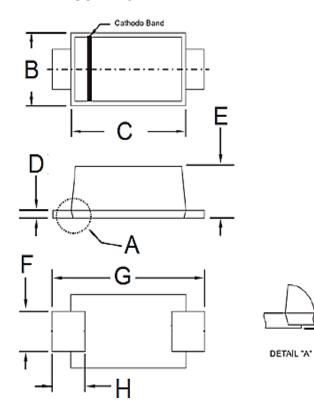


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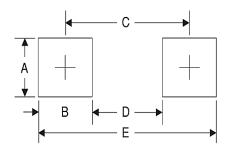
PACKAGE OUTLINE DIMENSIONS

SOD-123W



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
В	1.70	1.90	0.067	0.075	
С	2.60	2.90	0.102	0.114	
D	0.10	0.22	0.004	0.009	
Е	0.90	1.02	0.035	0.040	
F	0.90	1.05	0.035	0.041	
G	3.60	3.80	0.142	0.150	
Н	0.50	0.85	0.020	0.033	
I	0.00	0.10	0.000	0.004	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
Е	4.3	0.169

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code F = Factory Code



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